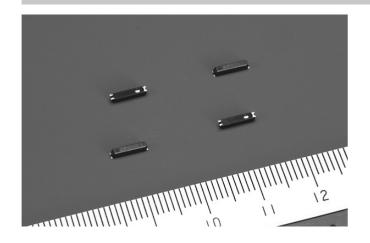


#### SSP-T7-F



### **FEATURES**

- Ultra thin type with height 1.4mm Max.
- SMD type suitable for automatic & high density surface mounting.
- Plastic mold package containing highly reliable tubular type quartz crystal.
- · Excellent shock and heat resistance.
- · RoHS directive compliant.

## **APPLICATIONS**

Cellular Phones, PDA, DSC, Car Audio, GPS Module, FM Tuner Module, ZigBee, Glucose Meter, Payment Terminal, Clock Source for Micro-Computers, Portable Applications etc.

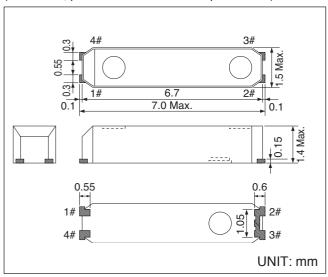
### STANDARD SPECIFICATIONS

Conditions without notice (Temperature:  $+25\pm2^{\circ}C$ , DL:  $0.1\mu W$ )

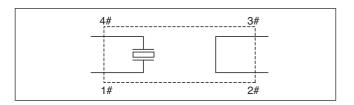
Item	Symbol	Specifications	Conditions / Notes
Nominal Frequency	f_nom	32.768kHz	
Frequency Tolerance	f_tol	±20 x 10 <sup>-6</sup> , ±50 x 10 <sup>-6</sup>	
Turnover Temperature	Ti	+25±5°C	
Parabolic Coefficient	В	(−3.5±1.0) x 10 <sup>-8</sup> /°C²	
Load Capacitance	CL	7.0 pF / 12.5pF	
Motional Resistance (ESR)	R <sub>1</sub> typ./max.	44kΩ / 65kΩ	
Absolute Maximum Drive Level	DLmax	1μW	
Level of Drive	DL	0.1μW	
Shunt Capacitance	C <sub>0</sub>	0.8pF typ.	
Frequency Ageing	f_age	±3 x 10 <sup>-6</sup>	+25±3°C, First Year
Operating Temperature	T_use	-40°C to +85°C	
Storage Temperature	T_stg	–55°C to +125°C	Piece part basis

## DIMENSIONS

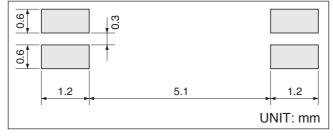
(For details, please refer to individual specification)



## INTERNAL LEAD CONNECTION



# RECOMMENDED SOLDERING PATTERN



- Remarks 1. Do not connect #2 and #3 to external device and GND.
  - **2.** The part of the cylinder inside resin mold may be sometimes exposed, however, it does not affect the characteristics of crystal unit.
  - 3. Please make sure that there is no pattern under SSP-T7-F on the circuit board.